

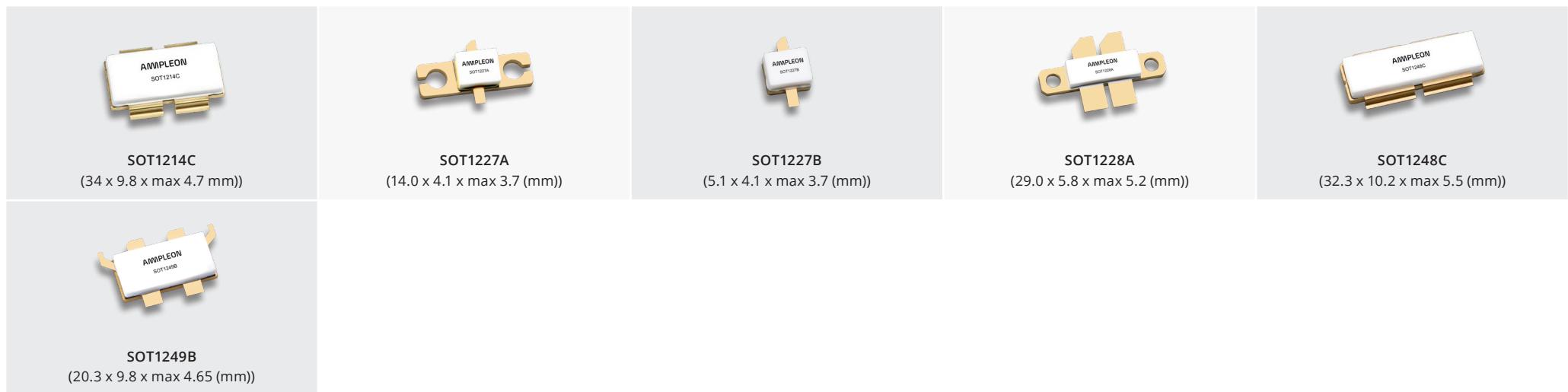
Ampleon package overview: www.ampleon.com/packages

Air-Cavity Ceramic (ACC) packages for RF power transistors*

 (L x W x H (mm))	 ACC-1230-6F-2 (32.26 x 10.16 x max. 5.5 (mm))	 ACC-1230-6F-3 (41.15 x 10.16 x max. 5.5 (mm))	 ACC-1230-6G-2 (32.26 x 10.16 x max. 5.5 (mm))	 SOT467B (9.7 x 5.8 x max 4.7 (mm))
 SOT467C (20.3 x 5.8 x max 4.7 (mm))	 SOT502A (34.0 x 9.8 x max 4.7 (mm))	 SOT502B (20.6 x 9.8 x max 4.7 (mm))	 SOT502E (20.6 x 9.8 x max 4.7 (mm))	 SOT502F (34.0 x 9.8 x max 4.7 (mm))
 SOT539A (41.2 x 10.2 x max 4.7 (mm))	 SOT539AN (41.2 x 10.2 x max 4.7 (mm))	 SOT539B (32.3 x 10.2 x max 4.7 (mm))	 SOT539BN (32.3 x 10.2 x max 4.7 (mm))	 SOT1121A (34.0 x 9.8 x max 4.7 (mm))
 SOT1121B (20.6 x 9.8 x max 4.7 (mm))	 SOT1135A (20.3 x 9.8 x max 4.7 (mm))	 SOT1135B (9.8 x 9.8 x max 4.7 (mm))	 SOT1214A (34.0 x 9.8 x max 4.7 (mm))	 SOT1214B (20.6 x 9.8 x max 4.7 (mm))

* Not drawn to scale

Air-Cavity Ceramic (ACC) packages for RF power transistors* (continued)



Air-Cavity Plastic (ACP) packages for RF power transistors*



* Not drawn to scale

Overmolded Plastic (OMP) packages for RF power transistors*

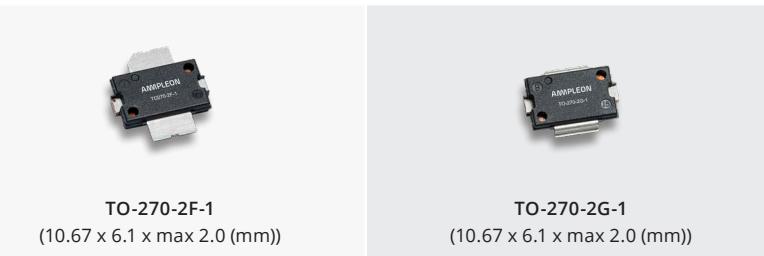
				
DFN-4.5x4-6-1 (4.0 x 4.5 x max. 0.85 (mm))	DFN-7x6.5-6-1 (7.0 x 6.5 x max. 0.85 (mm))	LGA-7x7-20-1 (7.0 x 7.0 x max. 1.0 (mm))	LGA-7x7-20-2 (7.0 x 7.0 x max. 1.0 (mm))	LGA-12x8-34-2 (12.0 x 8.0 x max. 0.98 (mm))
				
OMP-400-8F-1 (10.3 x 10.3 x max. 4.0 (mm))	OMP-400-8G-1 (10.3 x 10.3 x max. 4.0 (mm))	OMP-780-4F-1 (20.75 x 9.96 x max 4.0 (mm))	OMP-780-4G-1 (20.75 x 9.96 x max 4.0 (mm))	OMP-780-6F-1 (20.57 x 9.78 x max. 4.0 (mm))
				
OMP-780-16F-1 (20.75 x 9.96 x max 4.0 (mm))	OMP-780-16G-1 (20.75 x 9.96 x max 4.0 (mm))	OMP-1230-4F-1 (32.34 x 9.96 x max 4.0 (mm))	OMP-1230-4G-1 (32.34 x 9.96 x max 4.0 (mm))	OMP-1230-6F-1 (32.25 x 9.78 x max 4.0 (mm))
				
OMP-1230-6F-2 (32.25 x 9.78 x max 4.0 (mm))	PQFN-12x7-36-1 (12.0 x 7.0 x max. 2.2 (mm))	SOT1211-3 (20.75 x 9.96 x max 4.0 (mm))	SOT1212-3 (20.75 x 9.96 x max 4.0 (mm))	SOT1462-1 (8.0 x 8.0 x max 2.2 (mm))

* Not drawn to scale

Overmolded Plastic (OMP) packages for RF power transistors* (continued)



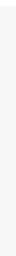
SOT1483-1
(10.67 x 6.1 x max 2.0 (mm))



TO-270-2F-1
(10.67 x 6.1 x max 2.0 (mm))



TO-270-2G-1
(10.67 x 6.1 x max 2.0 (mm))



QFN-8x8-20-1
(8 x 8 x max 1.05 (mm))

* Not drawn to scale